One-of-Ten Decoder

The LSTTL/MSI SN74LS42 is a Multipurpose Decoder designed to accept four BCD inputs and provide ten mutually exclusive outputs. The LS42 is fabricated with the Schottky barrier diode process for high speed and is completely compatible with all ON Semiconductor TTL families.

- Multifunction Capability
- Mutually Exclusive Outputs
- Demultiplexing Capability
- Input Clamp Diodes Limit High Speed Termination Effects



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LOW POWER SCHOTTKY

GUARANTEED OPERATING RANGES

Symbol	Parameter	Min	Тур	Max	Unit
Vcc	Supply Voltage	4.75	5.0	5.25	V
T _A	Operating Ambient Temperature Range	0	25	70	°C
ІОН	IOH Output Current – High			-0.4	mA
lOL	Output Current – Low			8.0	mA



PLASTIC N SUFFIX CASE 648



SOIC D SUFFIX CASE 751B



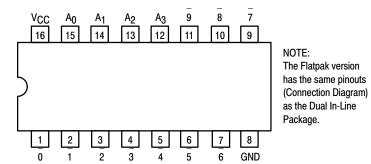
SOEIAJ M SUFFIX CASE 966

ORDERING INFORMATION

Device	Package	Shipping
SN74LS42N	16 Pin DIP	2000 Units/Box
SN74LS42D	SOIC-16	38 Units/Rail
SN74LS42DR2	SOIC-16	2500/Tape & Reel
SN74LS42M	SOEIAJ-16	See Note 1
SN74LS42MEL	SOEIAJ-16	See Note 1

 For ordering information on the EIAJ version of the SOIC package, please contact your local ON Semiconductor representative.

CONNECTION DIAGRAM DIP (TOP VIEW)



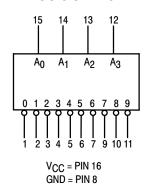
LOADING (Note a) HIGH LOW **PIN NAMES**

<u>A</u>0 -_A3 Address Inputs 0.5 U.L. 0.25 U.L. Outputs, Active LOW 0 to 9 10 U.L. 5 U.L.

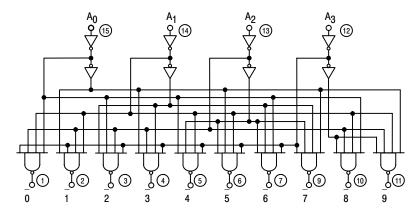
NOTES:

a) 1 TTL Unit Load (U.L.) = 40 μ A HIGH/1.6 mA LOW.

LOGIC SYMBOL



LOGIC DIAGRAM



V_{CC} = PIN 16 GND = PIN 8

= PIN NUMBERS

FUNCTIONAL DESCRIPTION

The LS42 decoder accepts four active HIGH BCD inputs and provides ten mutually exclusive active LOW outputs, as shown by logic symbol or diagram. The active LOW outputs facilitate addressing other MSI units with LOW input enables.

The logic design of the LS42 ensures that all outputs are HIGH when binary codes greater than nine are applied to the inputs.

The most significant input A_3 produces a useful inhibit function when the LS42 is used as a one-of-eight decoder. The A_3 input can also be used as the Data input in an 8-output demultiplexer application.

TRUTH TABLE

A ₀	Α ₁	A ₂	А3	0	1	2	3	4	5	6	7	8	9
L	L	L	L	L	Н	Н	Н	Н	Н	Н	Н	Н	Τ
Н	L	L	L	Н	L	Н	Н	Н	Н	Н	Н	Н	Н
L	Н	L	L	Н	Н	L	Η	Н	Н	Η	Η	Н	Н
Н	Н	L	L	Н	Н	Н	L	Н	Н	Н	Н	Н	Н
L	L	Н	L	Н	Η	Н	Η	L	Н	Η	Η	Η	Н
Н	L	Н	L	Н	Н	Н	Н	Н	L	Н	Н	Н	Н
L	Н	Н	L	Н	Η	Н	Η	Η	Н	L	Η	Η	Н
Н	Н	Н	L	Н	Н	Н	Н	Н	Н	Н	L	Н	Н
L	L	L	Н	Н	Η	Н	Η	Η	Н	Η	Η	L	Н
Н	L	L	Η	Н	Н	Н	Н	Н	Н	Н	Н	Н	L
L	Н	L	Η	Н	Η	Н	Η	Η	Н	Η	Η	Н	Н
Н	Н	L	Η	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н
L	L	Н	Η	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н
Н	L	Н	Η	Н	Η	Н	Η	Η	Н	Η	Η	Н	Н
L	Н	Н	Н	Н	Н	Η	Η	Н	Н	Η	Η	Н	Н
Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н

H = HIGH Voltage Level L = LOW Voltage Level

DC CHARACTERISTICS OVER OPERATING TEMPERATURE RANGE (unless otherwise specified)

		Limits					
Symbol	Parameter	Min	Тур	Max	Unit	Test C	onditions
VIH	Input HIGH Voltage	2.0			V	Guaranteed Input HIGH Voltage for All Inputs	
VIL	Input LOW Voltage			0.8	V	Guaranteed Input LOW Voltage for All Inputs	
VIK	Input Clamp Diode Voltage		-0.65	-1.5	V	$V_{CC} = MIN, I_{IN} = -18 \text{ mA}$	
VOH	Output HIGH Voltage	2.7	3.5		V	$V_{CC} = MIN, I_{OH} = MAX, V_{IN} = V_{IH}$ or V_{IL} per Truth Table	
.,	Outract LOW Valtages		0.25	0.4	٧	I _{OL} = 4.0 mA	V _{CC} = V _{CC} MIN,
VOL	Output LOW Voltage		0.35	0.5	٧	I _{OL} = 8.0 mA	V _{IN} = V _{IL} or V _{IH} per Truth Table
	land HIGH Compart			20	μΑ	V _{CC} = MAX, V _{II}	V = 2.7 V
¹IH	Input HIGH Current			0.1	mA	V _{CC} = MAX, V _{IN} = 7.0 V	
IIL	Input LOW Current			-0.4	mA	V _{CC} = MAX, V _{IN} = 0.4 V	
IOS	Short Circuit Current (Note 2)	-20		-100	mA	V _{CC} = MAX	
ICC	Power Supply Current			13	mA	V _{CC} = MAX	

^{2.} Not more than one output should be shorted at a time, nor for more than 1 second.

AC CHARACTERISTICS $(T_A = 25^{\circ}C)$

		Limits					
Symbol	Parameter	Min	Тур	Max	Unit	Tes	t Conditions
^t PLH ^t PHL	Propagation Delay (2 Levels)		15 15	25 25	ns	Figure 2	V _{CC} = 5.0 V
tPLH tPHL	Propagation Delay (3 Levels)		20 20	30 30	ns	Figure 1	C _L = 15 pF

AC WAVEFORMS

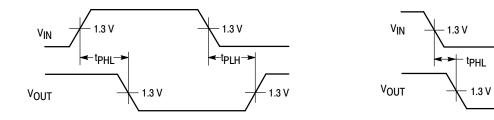
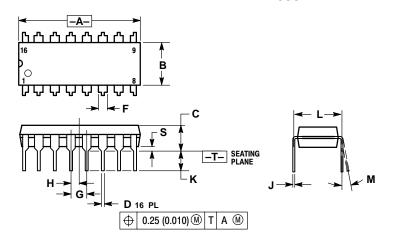


Figure 1. Figure 2.

PACKAGE DIMENSIONS

N SUFFIX PLASTIC PACKAGE CASE 648-08 ISSUE R

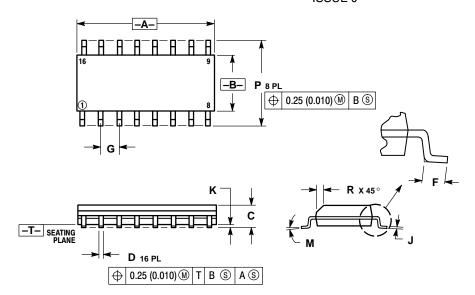


- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
 4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
 5. ROUNDED CORNERS OPTIONAL.

	INC	HES	MILLIN	IETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.740	0.770	18.80	19.55	
В	0.250	0.270	6.35	6.85	
С	0.145	0.175	3.69	4.44	
D	0.015	0.021	0.39	0.53	
F	0.040	0.70	1.02	1.77	
G	0.100	BSC	2.54 BSC		
Н	0.050	BSC	1.27 BSC		
J	0.008	0.015	0.21	0.38	
K	0.110	0.130	2.80	3.30	
L	0.295	0.305	7.50	7.74	
М	0°	10°	0°	10 °	
S	0.020	0.040	0.51	1.01	

PACKAGE DIMENSIONS

D SUFFIX PLASTIC SOIC PACKAGE CASE 751B-05 **ISSUE J**



NOTES:

- NOTES:

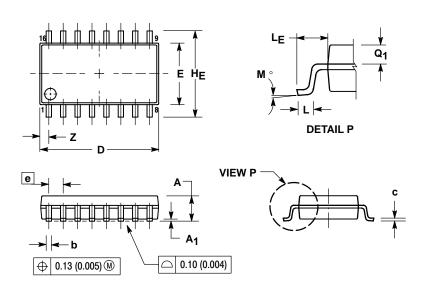
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.
 3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
 4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
 5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIN	IETERS	INC	HES
DIM	MIN	MIN MAX		MAX
Α	9.80	10.00	0.386	0.393
В	3.80	4.00	0.150	0.157
С	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27	BSC	0.050	BSC
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
Р	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019

PACKAGE DIMENSIONS

M SUFFIX

SOEIAJ PACKAGE CASE 966-01 **ISSUE O**



NOTES:

- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

 2. CONTROLLING DIMENSION: MILLIMETER.

 3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE
- PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006)
 PER SIDE.

 4. TERMINAL NUMBERS ARE SHOWN FOR
 REFERENCE ONLY.

 5. THE LEAD WIDTH DIMENSION (b) DOES NOT
 INCLUDE DAMBAR PROTRUSION. ALLOWABLE
 DAMBAR PROTRUSION SHALL BE 0.08 (0.003)
 TOTAL IN EXCESS OF THE LEAD WIDTH
 DIMENSION AT MAXIMUM MATERIAL CONDITION.
 DAMBAR CANNOT BE LOCATED ON THE LOWER
 RADIUS OR THE FOOT. MINIMUM SPACE
 BETWEEN PROTRUSIONS AND ADJACENT LEAD
 TO BE 0.46 (0.018).

	MILLIN	IETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α		2.05		0.081	
Α ₁	0.05	0.20	0.002	0.008	
b	0.35	0.50	0.014	0.020	
С	0.18	0.27	0.007	0.011	
D	9.90	10.50	0.390	0.413	
E	5.10	5.45	0.201	0.215	
е	1.27	BSC	0.050 BSC		
HE	7.40	8.20	0.291	0.323	
L	0.50	0.85	0.020	0.033	
LE	1.10	1.50	0.043	0.059	
M	0 °	10°	0 °	10 °	
Q ₁	0.70	0.90	0.028	0.035	
Z		0.78		0.031	

SN741 S42

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